

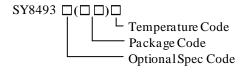
Application Note: SY8493

High Efficiency, 60V Input, 3A **Asynchronous Step Down Regulator**

General Description

The SY8493 develops a high efficiency, current mode adaptive constant off time controlled, asynchronous step-down DC/DC converter capable of delivering 3A output current. The SY8493 operates over a wide input voltage range from 4.5V to 60V and integrates main switch with very low R_{DS(ON)} to minimize the conduction loss. The switching frequency is adjustable from 100kHz to 500kHz using an external resistor. And the device features cycle-by-cycle peak current limitation.

Ordering Information



Ordering Number	Package type	Note	
SY8493FCC	SO8E		

Features

- Low R_{DS(ON)} for Internal N-channel Power FET(TOP):150mΩ
- 4.5-60V Input Voltage Range
- 3A Output Current Capability
- Adjustable Switching Frequency Range: 100kHz to 500kHz
- Internal Soft-start Limits the Inrush Current
- Hic-cup Mode Output Short Circuit Protection
- EN ON/OFF Control with Accurate Threshold
- Cycle-by-cycle Peak Current Limit
- 0.8V± 1% Reference Voltage Accuracy
- Compact Package: SO8E

Applications

- Non-isolated Telecommunication Buck Regulator
- Secondary High Voltage Post Regulator
- Automotive Systems
- Electric Bicycle

Typical Applications

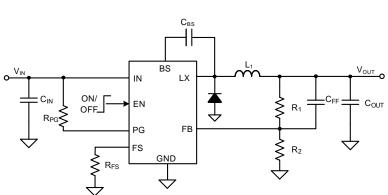


Figure 1. Schematic Diagram

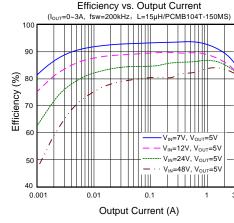
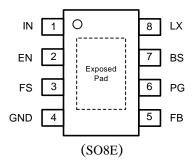


Figure 2. Efficiency vs. Output Current



Pinout (top view)



Top Mark: DHAxyz (Device code: DHA; x=year code, y=week code, z= lot number code)

Pin Name	Pin Number	Pin Description	
IN 1		Input pin. Decouple this pin to the GND pin with at least a 1µF ceramic capacitor.	
EN	2	Enable control. Pulled high to turn on. Do not leave it floating.	
FS	3	Frequency programming pin. Connect a resistor to ground to program a switching frequency between 100kHz to 500kHz. The switching frequency equals to: $fsw(kHz)=10^5/R_{FS}(k\Omega)$	
GND	4	Ground pin	
FB	5	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.8\times(1+R_1/R_2)$.	
PG	6	Power good Indicator. Open-drain output when the output voltage is within 90% to 120% of the regulation point.	
BS	7	Boot-strap pin. Supply high side gate driver. Connect a $0.1\mu F$ ceramic capacitor between the BS pin and the LX pin.	
LX	8	Inductor pin. Connect this pin to the switching node of the inductor.	
Exposed Pad			

Block Diagram

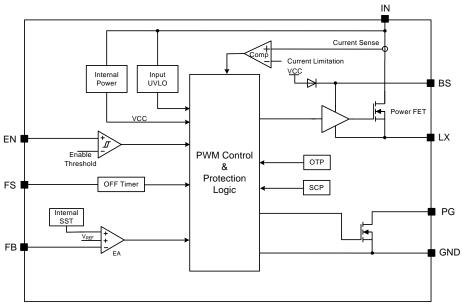


Figure 3. Block Diagram





Absolute Maximum Ratings (Note 1)	
Supply Input Voltage	
BS-LX Voltage	0.3V to 6V
EN, FS, FB, PG, LX Voltage	$-0.3V$ to $V_{IN} + 0.3V$
Power Dissipation, P _D @ T _A = 25°C, SO8E	2.38W
Package Thermal Resistance (Note 2)	
heta JA	42°C/W
heta JC	4°C/W
Junction Temperature Range	40°C to 150°C
Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	
Dynamic LX voltage in 10 ns duration	$V_{IN} + 3V$ to GND-5V
Recommended Operating Conditions (Note 3)	
Supply Input Voltage	4.5V to 60V
Junction Temperature Range	40°C to 125°C
Ambient Temperature Range	40°C to 85°C



Electrical Characteristics

(V_{IN} =24V, V_{OUT} = 5V, L =6.8uH, C_{OUT} = 22uF, T_A = 25°C, I_{OUT} =1A unless otherwise specified)

Parameter	Symbol	T _A = 25°C, I _{OUT} = 1A unless otherwise sp Test Conditions	Min	Тур	Max	Unit
Input Voltage Range	V_{IN}		4.5		60	V
Input UVLO Threshold	$V_{\rm UVLO}$		3.9	4.2	4.5	V
Input UVLO Hysteresis	V_{HYS}		0.19	0.27	0.35	V
Quiescent Current	I_Q	V _{FB} =V _{REF} ×105%	70	100	130	μΑ
Shutdown Current	I _{SHDN}	V _{EN} =0V	2	6	16	μΑ
Feedback Reference Voltage	V_{REF}		792	800	808	mV
FB Input Current	I_{FB}	$V_{FB}=3.3V$	-50		50	nA
Top FET R _{ON}	R _{DS(ON)}		120	150	180	mΩ
EN Rising Threshold	$V_{\text{EN,R}}$		1	1.1	1.2	V
EN Falling Threshold	$V_{EN,F}$		0.8	0.9	1	V
EN Leakage Current	I_{EN}		-1		1	μA
Min ON Time	t _{ON,MIN}			150		ns
Min OFF Time	t _{OFF,MIN}			250		ns
Soft-start Time	t_{SS}			2		ms
Switching Frequency Program Range	$f_{SW,RNG}$	R _{FS} =200k~1M	100		500	kHz
Switching Frequency Setting Accuracy	f_{SW}	R _{OSC} =200k	400	500	600	kHz
	$ m V_{PG}$	V _{FB} falling, PG from high to low	87	90	94	$%V_{REF}$
Power Good Threshold		V _{FB} rising, PG from low to high	91	95	98	$%V_{REF}$
Fower Good Threshold		V _{FB} rising, PG from high to low	115	120	123	$%V_{REF}$
		V _{FB} falling, PG from low to high	111	115	118	$%V_{REF}$
Denver Cood Delen	t _{PG_F}	High to low		20		μs
Power Good Delay	t _{PG_R}	Low to high		200		μs
Power Good Output Low	$V_{PG,L}$	I _{PG} =2mA			0.3	V
PG High Leakage Current					1	μΑ
Top FET Current Limit	I _{LMT,RNG}		3.8	4.5	5	A
Output Under Voltage Protection Threshold	V_{UVP}		45	50	55	$%V_{REF}$
Output UVP Delay	t _{UVP,DLY}			10		μs
UVP Hiccup ON Time	t _{UVP,ON}			3		ms
UVP Hiccup OFF Time	t _{UVP,OFF}			20		ms
Thermal Shutdown Temperature	T _{SD}			150		°C
Thermal Shutdown Hysteresis	T _{HYS}			15		°С

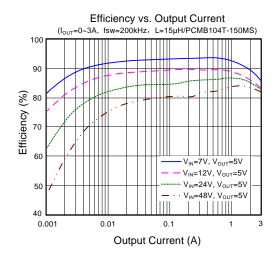
Note 1: Stresses beyond "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

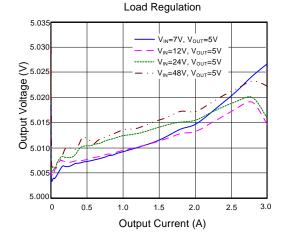
Note 2: θ_{JA} is measured in the natural convection at $T_A = 25$ °C on a two-layer Silergy demo board.

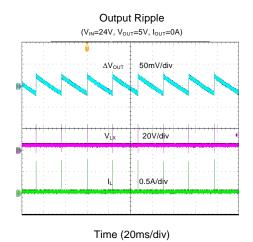
Note 3: The device is not guaranteed to function outside its operating conditions.

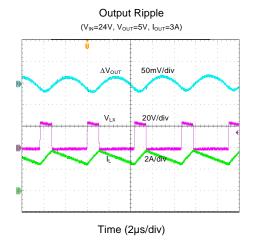


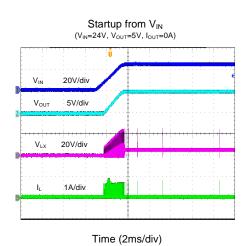
Typical Performance Characteristics

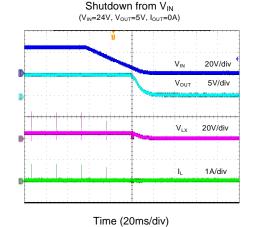




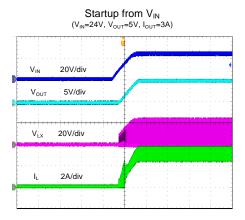




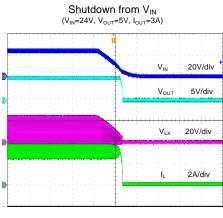




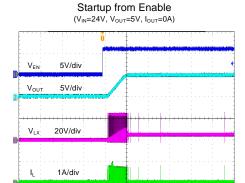




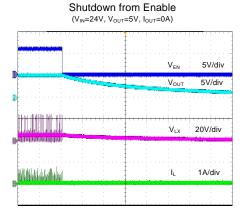
Time (2ms/div)



Time (20ms/div)

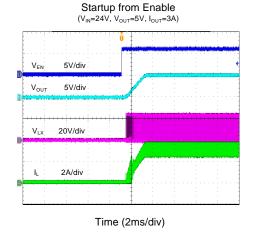


Time (2ms/div)



Time (1s/div)

Shutdown from Enable



(V_{IN}=24V, V_{OUT}=5V, I_{OUT}=3A)

V_{EN} 5V/div

V_{OUT} 5V/div

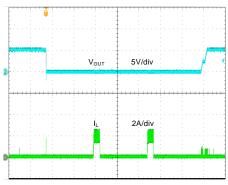
V_{LX} 20V/div

I_L 2A/div



Short Circuit Protection

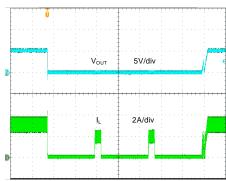
(V_{IN} =24V, V_{OUT} =5V, I_{OUT} =0A - Short)



Time (10ms/div)

Short Circuit Protection

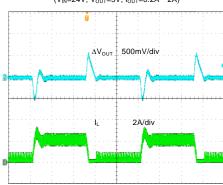
(V_{IN}=24V, V_{OUT}=5V, I_{OUT} =3A - Short)



Time (10ms/div)

Load transient

(V $_{IN}$ =24V, V $_{OUT}$ =5V, I $_{OUT}$ =0.2A - 2A)



Time (200µs/div)



Operation

The SY8493 is a high efficiency asynchronous step down DC/DC regulator capable of delivering 3A output current. The device adopts current mode adaptive constant OFF time control. The SY8493 operates over a wide input voltage range from 4.5V to 60V and integrates main switch with very low RDS(ON) to minimize the conduction loss.

The switching frequency is adjustable from 100kHz to 500kHz using an external resistor. And the device features cycle-by-cycle peak current limitation.

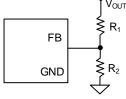
Applications Information

Because of the high integration in the SY8493, the application circuit based on this IC is rather simple. Only the input capacitor CIN, the output capacitor Cour, the output inductor L_1 and the feedback resistors (R₁ and R₂) need to be selected for the target applications.

Feedback Resistor Dividers R1 and R2:

Choose R₁ and R₂ to program the proper output voltage. To minimize the power consumption under light load, it is desirable to choose large resistance values for both R_1 and R_2 . A value of between $10k\Omega$ and $1M\Omega$ is highly recommended for both resistors. If V_{OUT} is 5V, $R_1=105k\Omega$ is chosen, then using the following equation, R_2 can be calculated to be $20k\Omega$:

$$R_2 = \frac{V_{FB}}{V_{OUT} - V_{FB}} R_1, V_{FB} \text{ is typical } 0.8V.$$



Input Capacitor CIN:

The ripple current through the input capacitor is calculated as:

$$\boldsymbol{I}_{\text{CIN, RMS}}\!=\!\!\boldsymbol{I}_{\text{OUT}}\!\times\!\sqrt{D(1\text{-}D)}$$

To minimize the potential noise problem, a typical X5R or better grade ceramic capacitor should be placed really close to the IN and the GND pins. Care should be taken to minimize the loop area formed by C_{IN} , and the IN/GND pins. In this case, a $1\mu F$ low ESR ceramic capacitor is recommended.

Output Capacitor Cout:

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. For the best performance, it is recommended to use an X5R or better grade ceramic capacitor greater than 22µF capacitance.

Output Inductor L:

There are several considerations in choosing this

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$V_{\text{OUT}}(1-V_{\text{OUT}}/V_{\text{INIMAX}})$$

$$L = \frac{V_{_{OUT}}(1 - V_{_{OUT}}/V_{_{IN,MAX}})}{f_{_{SW}} \times I_{_{OUT,MAX}} \times 40\%}$$

Where fsw is the switching frequency and the I_{OUT,MAX} is the maximum load current.

The SY8493 regulator is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

2) The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

$$I_{\text{SAT, MIN}} > I_{\text{OUT, MAX}} + \frac{V_{\text{OUT}}(1\text{-}V_{\text{OUT}}/V_{\text{IN,MAX}})}{2 \times f_{\text{SW}} \times L}$$

The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<50mΩ to achieve a good overall efficiency.

Enable Operation

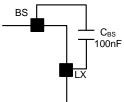
Pulling the EN pin low (<0.8V) will shut down the device. During the shutdown mode, the SY8493 shutdown current will drop to lower than 6μA(typ.). Driving the EN pin high (>1.2V) will turn on the IC

It is not recommended to connect EN and IN directly. A resistor in a range of $10k\Omega$ to $1M\Omega$ should be used if EN is pulled high by IN.



External Bootstrap Capacitor

This capacitor provides the gate driver voltage for internal high side MOSFET. A 100nF low ESR ceramic capacitor connected between the BS pin and the LX pin is recommended.



Adjustable Switching Frequency:

The FS pin is used for setting the switching frequency of the device by connecting a resistor from the FS pin to GND. The switching frequency of the device is adjustable from 100 kHz to 500kHz.

 $fsw(kHz)=10^5/R_{FS}(k\Omega)$

The SY8493 linearly folds back the switching frequency when the FB voltage is within 0~50% of the reference voltage during soft-start and the SCP event. The minimum switching frequency is clamped to 50kHz.

Power Good Indication

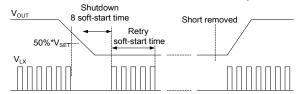
PG is an open-drain output pin. This pin will be pulled to ground if the output voltage is lower than 90% of regulation voltage or higher than 120% of regulation voltage. Otherwise this pin will go to a high impedance state.

Over-current Protection (OCP)

The SY8493 features cycle-by-cycle peak current limit. When the peak current limit is triggered, the device will turn off the high side MOSFET and turn on the low side MOSFET until the next cycle clock is coming.

Short-circuit Protection (SCP)

If V_{OUT} < 50% of the set-point continuously for approximately 10 µs, the short-circuit protection mode will be initiated, and the device will shut down for 8 soft-start time. The device will then restart with a complete soft-start cycle. If the short circuit condition remains, another 'hiccup' cycle of shutdown and restart will continue indefinitely.



Over-temperature Protection (OTP)

The device includes over-temperature protection (OTP) circuitry to prevent overheating due to excessive power dissipation. This will shut down switching operation when the junction temperature exceeds 150°C. Once the junction temperature cools down by approximately 15°C the IC will resume normal operation after a complete softstart cycle. For continuous operation, provide adequate cooling so that the junction temperature does not exceed the OTP threshold.

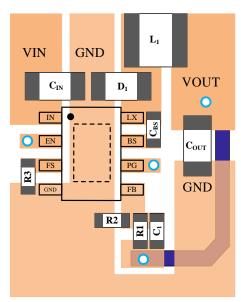
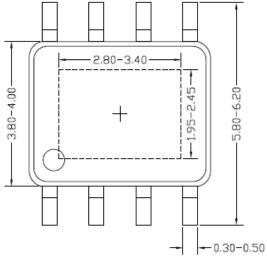
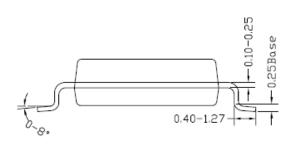


Figure 4. PCB Layout Suggestion

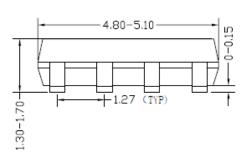


SO8E Package Outline & PCB Layout

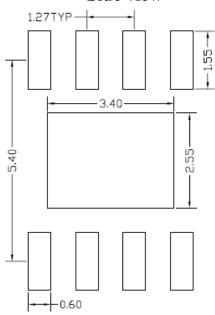




Top view



Side view



Front view

Recommended PCB layout (Reference Only)

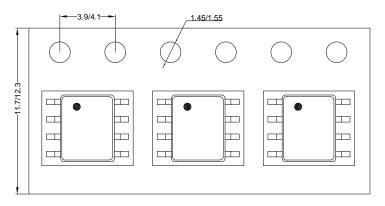
All dimension in millimeter and exclude mold flash & metal burr. **Notes:**



Taping & Reel Specification

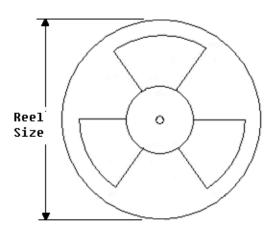
1. Taping orientation

SO8E



Feeding direction →

2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SO8E	12	8	13"	400	400	2500

3. Others: NA





Revision History

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
Sep.29, 2020	Revision 0.9	Initial Release



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